#### SILICON (Si) POWER MOSFET A CEF07N65SA



# CEF07N65SA

# 650V A 550mΩ A 7ANote 4 A Si MOSFET

SILICON SI MOSFET A THT type N-channel enhancement mode UL94V-0 rated flame retardant epoxy TO220F-3L package ▲ Electrical insulated mounting tab Super high dense cell density for extremely low R<sub>DS(ON)</sub> High power and current handling capability



Parameter (T <sub>c</sub> = 25°C, unless otherwise noted)		Characteristics
Drain-Source Voltage	V <sub>DS</sub>	650V
Gate-Source Voltage	V <sub>GS</sub>	±30V
Continuous Drain Current at T <sub>c</sub> = 25°C	Ι <sub>D</sub>	7A Note 4
Continuous Drain Current at T <sub>c</sub> = 100°C	Ι <sub>D</sub>	4.4A Note 4
Pulsed Drain Current Note 1	IDM Note 5	28A Note 4
Maximum Power Dissipation at T <sub>c</sub> = 25°C	PD	34W
Power Dissipation Derating above 25°C	ΔP <sub>D</sub>	0.27W/°C
Single Pulsed Avalanche Energy Note 6	E <sub>AS</sub>	120mJ
Single Pulsed Avalanche Current Note 6	I <sub>AS</sub>	2A
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55°C to +150°C

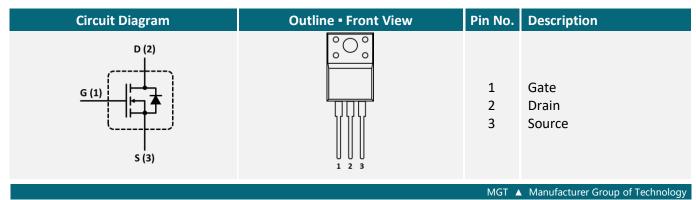
## **THERMAL CHARACTERISTICS**

Parameter	Symbol	Limit
Thermal Resistance, Junction-to-Case	R <sub>TH_JC</sub>	3.7°C/W
Thermal Resistance, Junction-to-Ambient	R <sub>th_ja</sub>	65°C/W

#### **APPLICATIONS**



#### **PIN DESCRIPTION**



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## **ELECTRICAL CHARACTERISTICS** A T<sub>c</sub> = 25°C, unless otherwise noted

Item	Condition	Symbol	Min.	Тур.	Max.	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	BV <sub>DSS</sub>	650			V
Zero Gate Voltage Drain Current	$V_{DS}$ = 650V, $V_{GS}$ = 0V	I <sub>DSS</sub>			1	μΑ
Gate Body Leakage Current, Forward	$V_{GS} = 30V, V_{DS} = 0V$	I <sub>GSSF</sub>			100	nA
Gate Body Leakage Current, Reverse	$V_{GS}$ = -30V, $V_{DS}$ = 0V	I <sub>GSSR</sub>			-100	nA
On Characteristics Note 2						
Gate Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 250 \mu A$	V <sub>GS(th)</sub>	2.5		4.5	V
Static Drain-Source On-Resistance	$V_{GS} = 10V, I_{D} = 5A$	R <sub>DS(ON)</sub>		550	650	mΩ
Dynamic Characteristics Note 3						
Input Capacitance	$V_{DS}$ = 150V, $V_{GS}$ = 0V, f = 1MHz	CISS		485		рF
Output Capacitance	$V_{DS} = 150V, V_{GS} = 0V, f = 1MHz$	Coss		55		рF
Reverse Transfer Capacitance	$V_{DS}$ = 150V, $V_{GS}$ = 0V, f = 1MHz	C <sub>RSS</sub>		20		рF
Switching Characteristics Note 3						
Turn-On Delay Time	$V_{\text{DD}}$ = 300V, $V_{\text{GS}}$ = 15V, $I_{\text{D}}$ = 3.5A, $R_{\text{G}(\text{ext})}$ = 10 $\Omega$	t <sub>D(ON)</sub>		20		ns
Turn-On Rise Time	$V_{\text{DD}}$ = 300V, $V_{\text{GS}}$ = 15V, $I_{\text{D}}$ = 3.5A, $R_{\text{G}(\text{ext})}$ = 10 $\Omega$	t <sub>R</sub>		7		ns
Turn-Off Delay Time	$V_{\text{DD}}$ = 300V, $V_{\text{GS}}$ = 15V, $I_{\text{D}}$ = 3.5A, $R_{\text{G(ext)}}$ = 10 $\Omega$	t <sub>D(OFF)</sub>		41		ns
Turn-Off Fall Time	$V_{\text{DD}}$ = 300V, $V_{\text{GS}}$ = 15V, $I_{\text{D}}$ = 3.5A, $R_{\text{G(ext)}}$ = 10 $\Omega$	t <sub>F</sub>		10		ns
Total Gate Charge	$V_{DS}$ = 480V, $V_{GS}$ = 10V, $I_{D}$ = 3.5A	$Q_{G}$		12		nC
Gate Source Charge	$V_{DS}$ = 480V, $V_{GS}$ = 10V, $I_{D}$ = 3.5A	Q <sub>GS</sub>		2.2		nC
Gate Drain Charge	$V_{DS}$ = 480V, $V_{GS}$ = 10V, $I_{D}$ = 3.5A	$\mathbf{Q}_{GD}$		5.3		nC
Drain-Source Diode Characteristics a	nd Maximum Ratings					
Drain-Source Diode Forward Current		ls			4.6	А
Drain-Source Diode Forward Voltage Note 2	$V_{GS} = 0V$ , $I_{S} = 4.6A$	$V_{\text{SD}}$			1.5	V

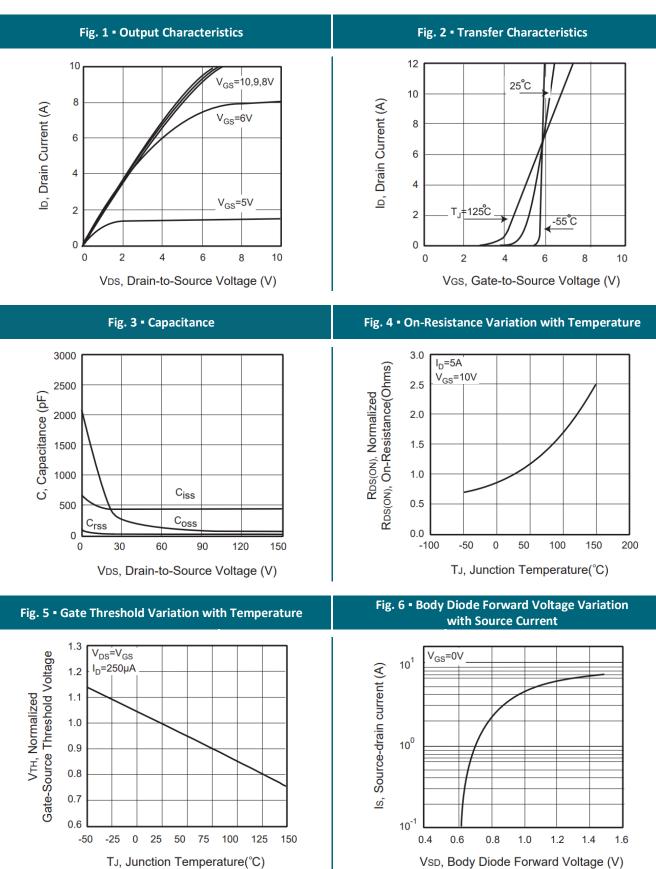
#### Notes

- 1: Repetitive Rating: Pulse width limited by maximum junction temperature
- 2: Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 3: Guaranteed by design, not subject to production testing.
- 4: Limited only by maximum temperature allowed.
- 5: Pulse width limited by safe operating area.
- 6: L = 60mH,  $I_{AS}$  = 2A,  $V_{DD}$  = 50V,  $R_G$  = 25Ω, Starting  $T_J$  = 25°C



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# **REFERENCE DATA ▲ TYPICAL DEVICE PERFORMANCE**



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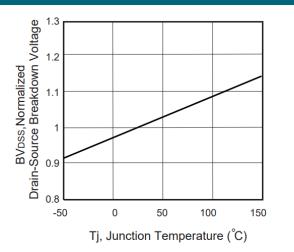
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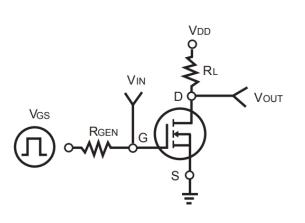
## **REFERENCE DATA A TYPICAL DEVICE PERFORMANCE**

Fig. 7 • Gate Charge

#### Fig. 9 - Breakdown Voltage Variation vs. Temperature







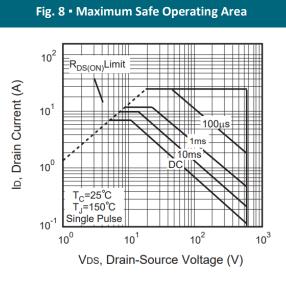
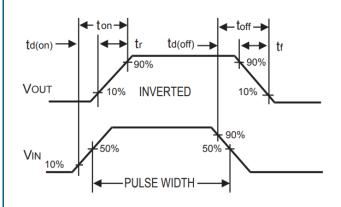


Fig. 11 • Switching Waveforms



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# **REFERENCE DATA ▲ TYPICAL DEVICE PERFORMANCE**

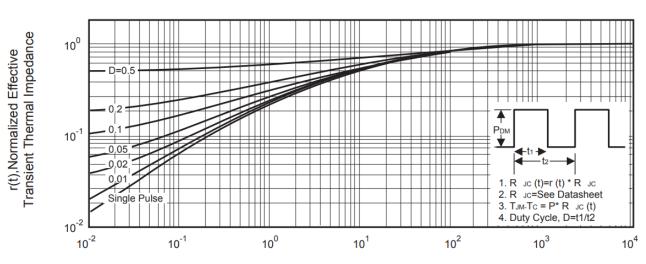


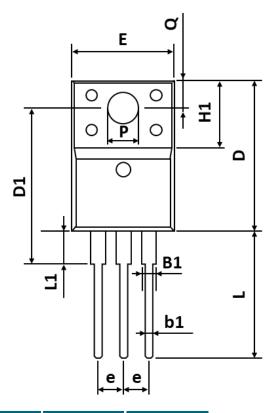
Fig. 12 • Normalized Thermal Transient Impedance Curve

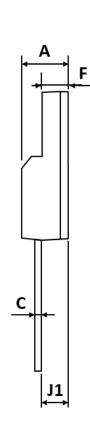
Square Wave Pulse Duration (msec)



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# **PACKAGE OUTLINE**





Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)
А	4.500	-	5.000
B1	1.000	-	1.500
b1	0.700	-	0.950
С	0.420	-	0.700
D	15.670	-	16.070
D1	14.800	-	16.000
E	9.960	-	10.360
е	2.340	-	2.740
F	2.340	-	2.740
H1	6.480	-	6.900
J1	2.550	-	2.950
L	12.080	-	13.480
L1	2.230	-	3.650
Q	3.100	-	3.500
Р	2.980	-	3.380

# **ORDERING INFORMATION**

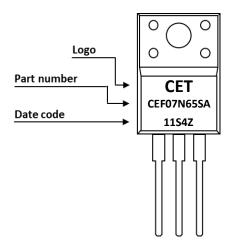
Part Number	Package	Packing	Tube Qty.	Inner Box Qty.	Outer Box Qty.
CEF07N65SA	TO-220F-3L	Tube	50pcs	1,000pcs	4,000pcs

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#### **PART MARKING**



# DATE CODE

Example: 11S4Z



| Product Type Z: Pb-free G: Green Product

Coding list for "Day"									
<b>1</b>	<b>2</b>	<b>3</b>	<b>4</b>	<b>5</b>	<b>6</b>	<b>7</b>	<b>8</b>	<b>9</b>	<b>A</b>
01	02	03	04	05	06	07	08	09	10
<b>B</b>	<b>C</b>	<b>D</b>	<b>E</b>	<b>F</b>	<b>G</b>	<b>H</b>	┃	<b>J</b>	<b>K</b>
11	12	13	14	15	16	17	18	19	20
<b>L</b>	<b>M</b>	<b>N</b>	<b>0</b>	<b>P</b>	<b>Q</b>	<b>R</b>	<b>S</b>	<b>T</b>	<b>U</b>
21	22	23	24	25	26	27	28	29	30
<b>V</b> 31									

Coding list for "Month"

<b>1</b> Jan	<b>2</b> Feb		5 May	
<b>7</b>	<b>8</b>	<b>A</b>	<b>B</b>	<b>C</b>
Jul	Aug	Oct	Nov	Dec

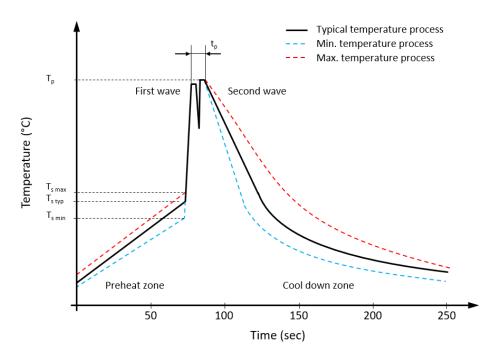
Coding list for "Year"







# **RECOMMENDED WAVE SOLDERING PROFILE ▲ THT PACKAGE**



#### Classification wave soldering profile ▲ Refer to EN 61760-1: 2006

Profile Features		Value 🛦 Sn-Pb Assembly	Value 🔺 Pb-free Assembly
Preheat temperature min.	$T_{s min}$	100 °C	100 °C
Preheat temperature typical	T <sub>s typ</sub>	120 °C	120 °C
Preheat temperature max.	$T_{s max}$	130 °C	130 °C
Preheat time $t_s$ from $T_{s min}$ to $T_{s max}$	ts	70 seconds	70 seconds
Peak temperature	Tp	235 °C to 260 °C	245 °C to 260 °C
Time of actual peak temperature	t <sub>p</sub>	Max. 10 seconds Max. 5 second each wave	Max. 10 seconds Max. 5 second each wave
Ramp-down date min.		~ 2 °C/second	~ 2 °C/second
Ramp-down rate typical		~ 3.5 °C/second	~ 3.5 °C/second
Ramp-down rate max.		~ 5 °C/second	~ 5 °C/second
Time 25°C to 25°C		4 minutes	4 minutes

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#### **REVISION TABLE**

Revision	Date	Status	Notes
001	30/09/2022	Initial release	Initial publication

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